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PATENT APPLICATION
Attorney Docket No.9898-206

4/ elected
Shaw
5/30/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Shin KIM, et al.

Serial No. 10/068,628

Examiner:

Dinh, Tuan T

Filed: February 6, 2002

Group Art Unit:

2827

For: SEMICONDUCTOR DEVICE BONDING PAD RESISTANT TO
STRESS AND METHOD OF FABRICATING THE SAME

Assistant Commissioner for Patents
Washington, D.C. 20231

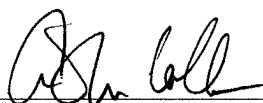
RECEIVED
MAY 20 2002
TC 2800 MAIL ROOM

RESPONSE TO RESTRICTION REQUIREMENT

Responsive to the Restriction Requirement, dated April 22, 2002, Applicant
hereby elects Group I (claims 1-14 and 20), without traverse.

Respectfully submitted,

MARGER JOHNSON &
McCOLLOM, PC


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Registration No. 28,881

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